

4

3

2

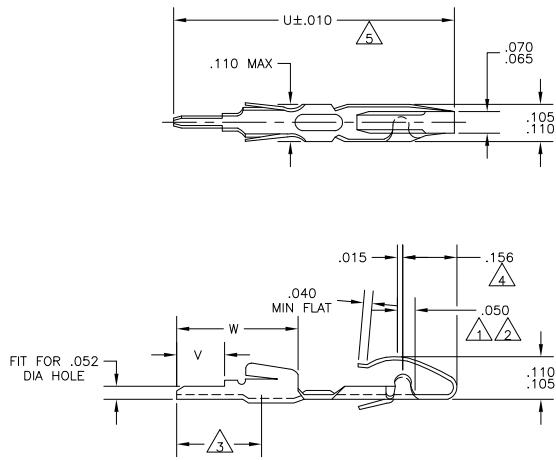
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LOC	DIST	REVISIONS			
P	LTR	DESCRIPTION	DATE	MIN	APVD
AD	00				
	K	ECO-05-004683	17JAN06	BSV	MM

NOTE:
FINISH

- 1 .000030 GOLD OVER NICKEL SELECTIVE ON CONTACT AREA.
- 2 .000015 GOLD OVER .000050 NICKEL SELECTIVE ON CONTACT AREA.
- 3 GOLD FLASH OR TIN PLATE OVER NICKEL ON SOLDER TAB.
- 4 GOLD PLATING THICKNESS TO BE MEASURED WITH A MASK HAVING A .012 APERTURE LOCATED .156 FROM THE NOSE OF CONTACT
- 5 .000100/.000200 BRIGHT TIN LEAD PLATING ALL OVER, NICKEL UNDER PLATE ALL OVER.
- 6 GOLD FLASH OR MATTE TIN PLATE OVER NICKEL ON SOLDER TAB.



	1/16	2	6	.345	.120	.810	5-583294-2
	1/16	1	6	.345	.120	.810	5-583294-1
OBSOLETE	1/16	2	6	.345	.120	.810	583294-8
OBSOLETE	3/32	2	6	.375	.150	.840	583294-4
OBSOLETE	3/32	1	6	.375	.150	.840	583294-3
	1/16	2	6	.345	.120	.810	583294-2
	1/16	1	6	.345	.120	.810	583294-1
	BOARD THK	FINISH		W	V	U	PART NO.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWG	26SEP67	Tyco Electronics Corporation	
		CHK	14SEP67	Harrisburg, PA 17105-3608	
DIMENSIONS: INCHES		APVD	16SEP67	NAME	
OTHER FINISHES: SEE TABLE		PRODUCT SPEC		AMP LEAF SOLDER DIP CONTACT FOR .052 DIA.HOLE	
MATERIAL: PHOSPHOR BRONZE		APPLICATION SPEC		SIZE	CHG CODE
FINISH: SEE TABLE		HEIGHT		A2	00779
		CUSTOMER DRAWING		SCALE	5:1
				SHEET	1 OF 1
				REV	K

AMP 1471-9 REV 31MM2000

01MAY06 8:33am us001193 H:\dmtmod\ECO\eco-05-004683\583294-c.dwg